

Data sheet acquired from Harris Semiconductor SCHS057C – Revised September 2003

# CD4073B, CD4081B, CD4082B Types

### **CMOS AND Gates**

High-Voltage Types (20-Volt Rating)

CD4073B Triple 3-Input AND Gate CD4081B Quad 2-Input AND Gate CD4082B Dual 4-Input AND Gate

CD4073B, CD4081B and CD-4082B AND gates provide the system designer with direct implementation of the AND function and supplement the existing family of CMOS gates.

The CD4073B, CD4081B, and CD4082B types are supplied in 14-lead hermetic dual-in-line ceramic packages (F3A suffix), 14-lead dual-in-line plastic packages (E suffix), 14-lead small-outline packages (M, MT, M96, and NSR suffixes), and 14-lead thin shrink small-outline packages (PW and PWR suffixes).

#### Features:

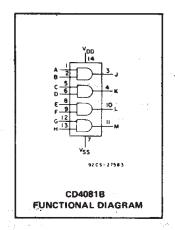
- Medium-Speed Operation tpLH, tpHL = 60 ns (typ.) at V<sub>DD</sub> = 10 V
- 100% tested for quiescent current at 20 V
- Maximum input current of 1 μA at 18 V over full package-temperature range; 100 nA at 18 V and 25°C
- Noise margin (full package-temperature range) =

1 V at  $V_{DD}$  = 5 V

2 V at V<sub>DD</sub> = 10 V

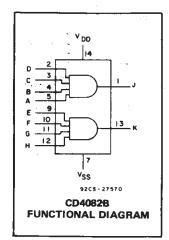
2.5 V at VDD = 15 V

- Standardized, symmetrical output characteristics
- 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Discription of 'B' Series CMOS Devices"



### MAXIMUM RATINGS, Absolute-Maximum Values:

| DC SUPPLY-VOLTAGE RANGE, (VDD)   |
|--|
| Voltages referenced to V <sub>SS</sub> Terminal)                                 |
| INPUT VOLTAGE RANGE, ALL INPUTS0.5V to V <sub>DD</sub> +0.5V                     |
| DC INPUT CURRENT, ANY ONE INPUT  |
| POWER: DISSIPATION PER PACKAGE-(Pb):   |
| For T <sub>A</sub> = -55°C to +100°C   |
| For T <sub>A</sub> = +100%C to +125%C  |
| DEVICE DISSIPATION PER OUTPUT TRANSISTOR   |
| FOR TA = FULL PACKAGE TEMPERATURE RANGE (All Package Types)                      |
| OPERATING-TEMPERATURE RANGE (T <sub>A</sub> )55°C to +125°C                      |
| STORAGE TEMPERATURE RANGE (T <sub>stg</sub> )65°C to +150°C                      |
| LEAD TEMPERATURE (DURING SOLDERING):   |
| At distance 1/16 $\pm$ 1/32 inch (1.59 $\pm$ 0.79mm) from case for 10s max+265°C |



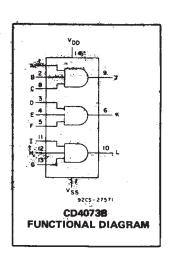
#### RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

| CHADACTERISTIC   | LIM  |      |       |
|--|------|------|-------|
| CHARACTERISTIC   | MIN. | MAX. | UNITS |
| Supply-Voltage Range (For T <sub>A</sub> = Full Package Temperature Range) | 3    | 18   | ٧     |

# DYNAMIC ELECTRICAL CHARACTERISTICS at TA=25°C, Input t<sub>r</sub>,t<sub>f</sub>=20 ns, and CL=50 pF, R<sub>L</sub>=200 k $\Omega$

| CHARACTE <b>RÍSTIC</b>                               | TEST COND | ITIONS                   | ALL T           |                  |       |
|--|-----------|--------------------------|-----------------|------------------|-------|
| CHARACTEMENT   |           | V <sub>DD</sub><br>Volts | TYP.            | MAX.             | UNITS |
| Propagation Delay Time,                              |           | 5<br>10<br>15            | 125<br>60<br>45 | 250<br>120<br>90 | ns    |
| Transition Time, <sup>t</sup> THL <sup>, t</sup> TLH |           | 5<br>10<br>15            | 100<br>50<br>40 | 200<br>100<br>80 | ns    |
| Input Capacitance, C <sub>IN</sub>                   | Any Input | _                        | 5               | 7.5              | ρF    |



# CD4073B, CD4081B, CD4082B Types

#### STATIC ELECTRICAL CHARACTERISTICS

| CHARACTER-                                      | CONDITIONS |                |      | LIMITS AT INDICATED TEMPERATURES (°C) |       |       |       |       |                   |      |       |
|---|------------|----------------|------|---------------------------------------|-------|-------|-------|-------|-------------------|------|-------|
| ISTIC   | Vo         | VIN            | VDD  |                                       |       |       |       | +25   |                   |      | UNITS |
|   | (v)        | (V)            | (V)  | -55                                   | -40   | +85   | +125  | Min.  | Тур.              | Max. |       |
| Quiescent Device                                | 1          | 0,5            | 5    | 0.25                                  | 0.25  | 7.5   | 7.5   | _     | 0.01              | 0.25 |       |
| Current,  | +          | 0,10           | 10   | 0.5                                   | 0.5   | 15    | 15    | _     | 0.01              | 0.5  |       |
| IDD Max.  |            | 0,15           | 15   | 1                                     | 1     | 30    | 30    | -     | 0,01              | 1    | . µА  |
|   |            | 0,20           | 20   | 5                                     | 5     | 150   | 150   | _     | 0.02              | 5    | ,     |
| Output Low                                      | 0.4        | 0,5            | 5    | 0.64                                  | 0.61  | 0.42  | 0.36  | 0.51  | 1                 |      | :     |
| (Sink) Current                                  | 0,5        | 0,10           | 10   | 1.6                                   | 1.5   | 1.1   | 0.9   | 1.3   | 2.6               | -    | •     |
| 1OL Min.  | 1.5        | 0,15           | 15   | 4.2                                   | 4     | 2.8   | 2.4   | 3 4   | 6.8               | _    |       |
| Output High<br>(Source)<br>Current,<br>IOH Min. | 4.6        | 0,5            | 5    | -0.64                                 | -0.61 | -0.42 | -0.36 | -0.51 | -1                | -    | mΑ    |
|   | 2.5        | 0,5            | 5    | 2                                     | -1.8  | -1.3  | -1.15 | -1.6  | -3.2              | _    |       |
|   | 9.5        | 0,10           | 10   | <del>,-</del> 1.6                     | -1.5  | -1.1  | -0.9  | -1.3  | -2.6              |      |       |
|   | 13.5       | 0,15           | - 15 | -4.2                                  | -4    | -2.8  | 2.4   | -3.4  | <b>-</b> 6.8      | -    |       |
| Output Voltage:                                 |            | 0,5            | 5    |                                       | 0     | .05   |       |       | 0                 | 0.05 |       |
| Low-Level,                                      |            | 0,10           | 10   |                                       | Ö     | .05   |       |       | 0                 | 0.05 |       |
| VOL Max   | i .        | 0,15           | 15   |                                       | 0     | .05   |       | -     | 0                 | 0.05 | ·v    |
| Dutput Voltäge:                                 |            | 0,5            | 5    |                                       | 4     | .95   |       | 4.95  | 5                 |      | . · V |
| High-Level,                                     | -          | 0,10           | 10   |                                       | 9     | .95   |       | 9.95  | 10                | -    | 7 I   |
| VOH Min.  | # ·        | 0,15           | 15   |                                       | 14    | .95   |       | 14.95 | 15                | _    |       |
| Input Low                                       | 0.5        | _              | 5    | ·                                     | 1     | .5    |       | _     | _                 | 1.5  |       |
| Voltage,  | 1          | . –            | 10   |                                       |       | 3     |       | _     | _                 | 3    |       |
| VIE Max.  | 1.5        | _              | 15   |                                       |       | 4     |       | _     | _                 | 4    | .,    |
| Input High                                      | 0.5,4.5    | , <del>-</del> | 5    |                                       | 3     | 3.5   |       | 3.5   | _                 | _    | V     |
| Voltage,  | 1,9        |                | 10   |                                       |       | 7     |       | 7     |                   |      |       |
| VIH Min.  | 1.5,13.5   |                | 15   |                                       |       | 1     |       | 11    | _                 | _    |       |
| Input Current IşN Max.                          |            | 0,18           | 18   | ±0.1                                  | ±0.1  | ±1    | ±1    | _     | ±10 <sup>-5</sup> | ±0.1 | μΑ    |

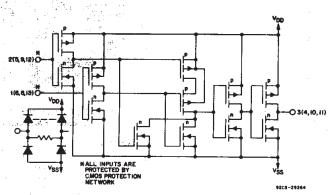


Fig. 1 - Schematic diagram for CD4081B (1 of 4 identical gates).

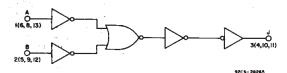


Fig. 2 - Logic diagram for CD4081B (1 of 4 identical gates).

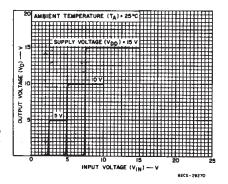


Fig. 3 - Typical voltage transfer characteristics.

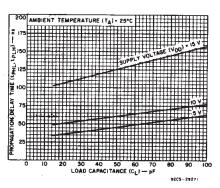


Fig. 4 — Typical propagation delay time as a function of load capacitance.

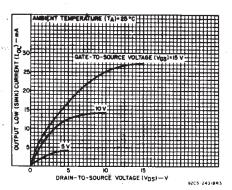


Fig. 5 — Typical output low (sink) current characteristics.

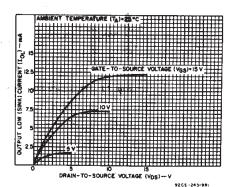


Fig. 6 — Minimum output low (sink) current characteristics.

## CD4073B, CD4081B, CD4082B Types

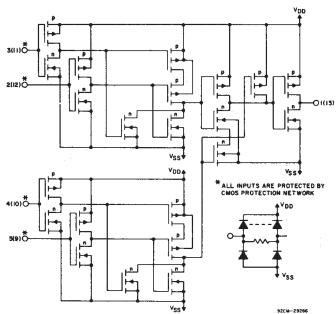


Fig. 7 — Schematic diagram for CD4082B (1 of 2 identical gates).

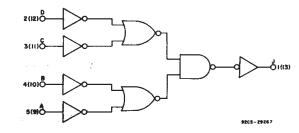


Fig. 9 - Logic diagram for CD4082B (1 of 2 identical gates).

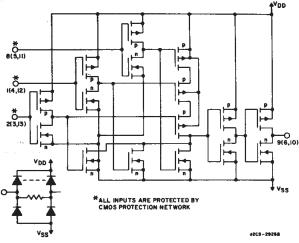


Fig. 11 — Schematic diagram for CD4073B (1 of 3 identical gates).

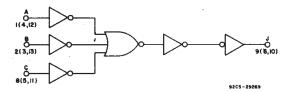


Fig. 13 — Logic diagram for CD4073B (1 of 3 identical gates).

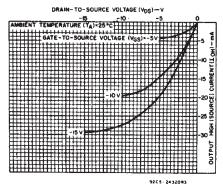


Fig. 8 - Typical output high (source) current characteristics.

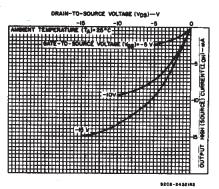


Fig. 10 — Minimum output high (source) current characteristics.

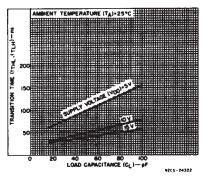


Fig. 12 — Typical transition time as a function of load capacitance

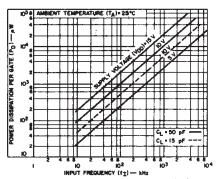


Fig. 14 — Typical dynamic power dissipation per gate as a function of frequency.

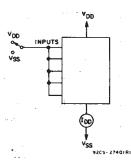


Fig. 15 - Quiescent device current test circuit.

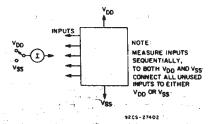


Fig. 16 - Input current test circuit.

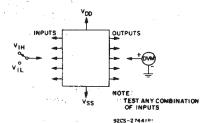
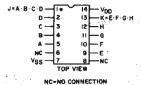


Fig. 17 - Input-voltage test circuit.

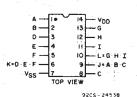
#### TERMINAL ASSIGNMENTS



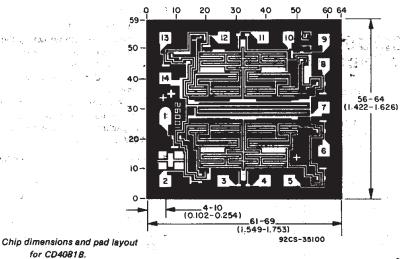
#### CD4081B

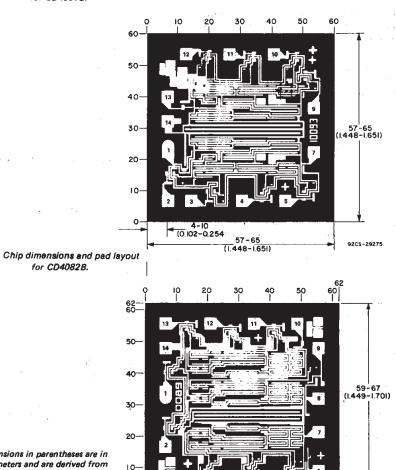


CD4082B



CD4073B





Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10<sup>-3</sup> inch).

Chip dimensions and pad layout (0.102-0.254)

Chip dimensions and pad layout (1.449-1.701)

### 14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

# N (R-PDIP-T\*\*)

## PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



# D (R-PDSO-G14)

## PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AB.



### **MECHANICAL DATA**

## NS (R-PDSO-G\*\*)

# 14-PINS SHOWN

### PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



### PW (R-PDSO-G\*\*)

#### 14 PINS SHOWN

### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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